PRELIMINARY DATA SHEET



MOS INTEGRATED CIRCUIT μ PD9611

FOUR-CHANNEL PCM CODEC

The μ PD9611 incorporates 4-channel A-law/ μ -law PCM CODECs compliant with ITU-T Recommendation G.711/ G.714 and is suitable for applications such as PBX analog subscriber line circuits.

Its gain setting circuit allows transmit/receive gain to be set for 4 channels independently by externally inputting digital signals.

FEATURES

- Single-chip CMOS monolithic LSI
- ITU-T Recommendation G.711/G.714 compliant
- Four-channel PCM CODECs integrated on a single chip
- Compatible with A-law and μ-law
- Digital gain setting for each channel
 - Transmit: +7.5 to -8.0 dB (0.5 dB step)
 - Receive: 0 to -15.5 dB (0.5 dB step)
- Data transfer system: Transmit/receive synchronization
- Data rate: 2048 kHz
- +5 V single power supply
- Power down function for each channel
- Low power consumption

ORDERING INFORMATION

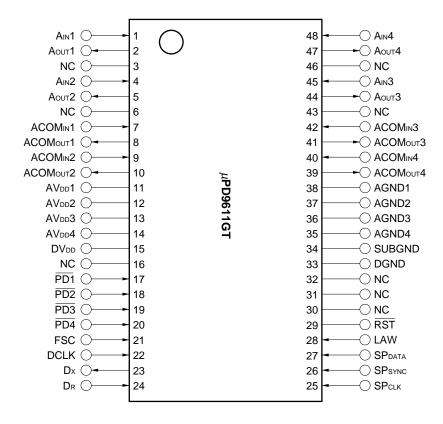
Part Number	Package
μPD9611GT	48-pin shrink SOP (375 mil)

The information in this document is subject to change without notice.



PIN CONFIGURATION (Top View)

48-pin shrink SOP (375 mil)



ACOMIN1-ACOMIN4 : Analog common voltage in Dx : Transmit PCM data out
ACOMOUT1-ACOMOUT4: Analog common voltage out FSC : Frame synchronous clock in
AGND1-AGND4 : Analog ground LAW : A-law/µ-law control in

AGND1-AGND4 : Analog ground LAW : A-law/ μ -law control in AIN1-AIN4 : Analog signal in NC : No connection AOUT1-AOUT4 : Analog signal out $\overline{PD1}$ - $\overline{PD4}$: Power down control AVDD1-AVDD4 : Analog power supply \overline{RST} : Reset in

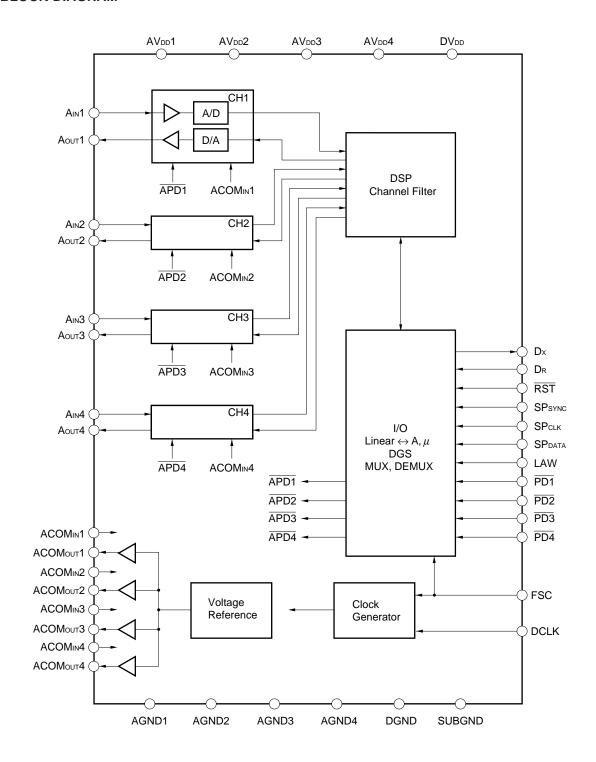
DCLK : Data clock in SPclk : Serial port data clock in DGND : Digital ground SPDATA : Serial port data in

DR : Receive PCM data in SPSYNC : Serial port synchronous clock in

DVDD : Digital power supply SUBGND : Sub ground



BLOCK DIAGRAM





1. PIN DESCRIPTION

Pin No.	Symbol	I/O	Name and Function
1	Ain1	I	Transmit analog input pin for channel 1 When not used, connect to ACOMou⊤1 pin.
2	Аоит1	0	Receive analog output pin for channel 1
3	NC	_	Leave this pin open.
4	Ain2	I	Receive analog input pin for channel 2 When not used, connect to ACOMoυτ1 pin.
5	Аоит2	0	Transmit analog output pin for channel 2
6	NC	-	Leave this pin open.
7	ACOM _{IN} 1	I	Signal reference voltage input for channel 1
8	АСОМоит1	0	Signal reference voltage output for channel 1
9	ACOM _{IN} 2	I	Signal reference voltage input for channel 2
10	АСОМоит2	0	Signal reference voltage output for channel 2
11	AV _{DD} 1	-	Analog power supply pin for channel 1 $+5 \pm 0.25 \text{ V}$
12	AV _{DD} 2	-	Analog power supply pin for channel 2 $\pm 5 \pm 0.25 \text{ V}$
13	AV _{DD} 3	-	Analog power supply pin for channel 3 $+5 \pm 0.25 \text{ V}$
14	AV _{DD} 4	-	Analog power supply pin for channel 4 $+5 \pm 0.25 \text{ V}$
15	DV _{DD}	-	Digital power supply pin $+5 \pm 0.25 \text{ V}$
16	NC	_	Leave this pin open.
17	PD1	I	Power-down control input pin for channel 1 Channel 1 enters power-down mode when this signal is low level. The output of Dx pin for channel 1 becomes high-impedance and Aout1 becomes signal reference voltage in the power-down mode.
18	PD2	I	Power-down control input pin for channel 2 Channel 2 enters power-down mode when this signal is low level. The output of Dx pin for channel 2 becomes high-impedance and Aout2 becomes signal reference voltage in the power-down mode.
19	PD3	_	Power-down control input pin for channel 3 Channel 3 enters power-down mode when this signal is low level. The output of Dx pin for channel 3 becomes high-impedance and Aout3 becomes signal reference voltage in the power-down mode.
20	PD4	1	Power-down control input pin for channel 4 Channel 4 enters power-down mode when this signal is low level. The output of Dx pin for channel 4 becomes high-impedance and Aout4 becomes signal reference voltage in the power-down mode.
21	FSC	I	Frame synchronous clock input pin (8 kHz)
22	DCLK	I	Data clock input pin (2048 kHz)
23	Dx	0	Transmit PCM data output pin This pin outputs PCM data for channel 1 to 4 in synchronization with rising edges of DCLK after rising edges of FSC. It becomes high-impedance for other timings.
24	Dr	I	Receive PCM data input pin This pin inputs PCM data for channel 1 to 4 in synchronization with falling edges of DCLK after rising edges of FSC.
25	SPclk	I	Setting data clock input pin
26	SPsync	I	Setting synchronous clock input pin
27	SPDATA	I	Setting data input pin



Pin No.	Symbol	I/O	Name and Function
28	LAW	I	A-law/μ-law select pin in common to four channels
			L: A-law, H: μ-law
29	RST	_	Reset input, power-on reset pin
			H: normal operation
			L: internal registers are in the default status.
30-32	NC	_	Leave this pin open.
33	DGND	_	Digital ground pin
34	SUBGND	_	Substrate ground pin
35	AGND4	_	Analog ground pin for channel 4
36	AGND3	_	Analog ground pin for channel 3
37	AGND2	_	Analog ground pin for channel 2
38	AGND1	_	Analog ground pin for channel 1
39	АСОМоит4	0	Signal reference voltage output for channel 4
40	ACOMin4	I	Signal reference voltage input for channel 4
41	АСОМоит3	0	Signal reference voltage output for channel 3
42	ACOM _{IN} 3	I	Signal reference voltage input for channel 3
43	NC	_	Leave this pin open.
44	Аоит3	0	Receive analog output pin for channel 3
45	Ain3	I	Transmit analog input pin for channel 3
			When not used, connect to ACOMou⊤1 pin.
46	NC	_	Leave this pin open.
47	Аоит4	0	Receive analog output pin for channel 4
48	Ain4	I	Transmit analog input pin for channel 4
			When not used, connect to ACOMoυτ1 pin.



2. CAUTIONS ON USE

(1) Absolute maximum ratings

Application of voltage or current in excess of the absolute maximum ratings to the μ PD9611 may result in damage due to latch up, etc. Be especially cautions about power supply noise, etc.

(2) Wiring pattern

The design of the ground pattern is extremely important for operating the μ PD9611 with high precision. Connect the analog ground pins (AGND1 to AGND4), digital ground pin (DGND) and substrate ground pin (SUBGND) close to the IC pins, and connect to a wide analog ground line on the board.

(3) Addition of bypass capacitors for power supply pins

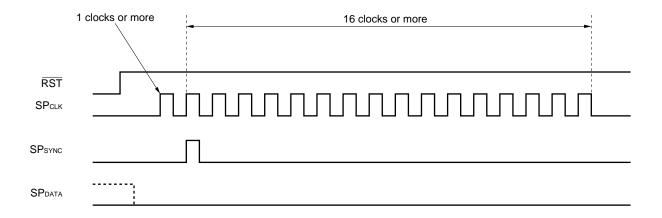
Because the μ PD9611 uses many internal high-frequency operational amplifiers, high power supply impedance can cause instability (such as oscillation) in these internal operational amplifiers. To suppress such instability and eliminate power supply noise, connect all power supply pins (AV_{DD}1 to AV_{DD}4, DV_{DD}) close to the IC pins, and put bypass capacitors (C_{VDD} = approximately 0.1 μ F) having superior high-frequency characteristics very close to the pins.

(4) Addition of bypass capacitors for ACOM pins

The μ PD9611 incorporates references voltages for signal sources. Superposing of noise on these reference voltages may have adverse effects on transmission characteristics, etc. Therefore, connect the ACOMout pin and ACOMin pin close to the IC pins, and put bypass capacitors (Cacom = approximately 0.1 μ F) having superior high-frequency characteristics very close to the pins.

(5) Control or SPDATA pin on reset

When inputting the setting data from the SPDATA pin after the μ PD9611 is reset, first input the following patterns to reset to 0 the couter used to fetch data from the SPDATA pin.



After ther \overline{RST} pin has been set to the high level, input 1 clock or more to the SPCLK pin, set the SPSYNC pin to the high level and input 16 clocks more to the SPCLK pin.

During this operation, the SPDATA pin is held at the low level. Afterwards, input the setting data.



3. GENERAL OPERATION

(1) PCM data transfer

In the transmit section, if FSC pin is set to the high level in synchronization with the rising edge (\uparrow) of the data clock applied to the DCLK pin, the Dx pin becomes active and sign bit data (MSB) of channel 1 is output. The following data of 7 bits is clocked out in synchronization with the rising edge (\uparrow) of each data clock. Sign bit data (MSB) of channel 2 is output in synchronization with the rising edge (\uparrow) of the 9th data clock. In the same manner, each data up to channel 4 is output and the rising edge (\uparrow) of the 33rd data clock then sets the Dx pin to high-impedance state.

Similarly, in the receive section, if the FSC pin is set to the high level in synchronization with the rising edge (\uparrow) of the data clock applied to the DCLK pin, data of D_R pin is latched by the falling edges (\downarrow) of the data clock and consecutively clocked in.

(2) Power down control

The μ PD9611 has the following two methods for power down control and is able to control power-down independently for each channel.

- Sets pins $\overline{PD1}$ to $\overline{PD4}$ to high or low level.
- Inputs 8-bit setting data from SPDATA pin (see (5) Control of SPDATA pin).

Internal data is the logical sum of PD1 to PD4 pin state and 8-bit setting data input.

If the internal data is 0, the channel enters the power-down state. If the internal data is 1, the channel enters the power-up state. In the power down state, PCM data in the channel goes to high-impedance state and analog output becomes the signal reference voltage level.

8-Bit Setting Data (Channel 1)	PD1 Pin	Internal Data
0	0	0
1	0	1
0	1	1
1	1	1

Remarks 1. 0: Power down, 1: Power up

2. The settings are the same for channel 2 to channel 4.



(3) A-law/ μ -law control

The μ PD9611 has the following two methods for A-law/ μ -law control.

- · Sets LAW pin to high or low level.
- Inputs 8-bit setting data from SPDATA pin (see (5) Control of SPDATA pin).

Internal data is the logical sum of LAW pin state and 8-bit setting data input.

If the internal data is 0, the μ PD9611 enters A-law mode. If the internal data is 1, the μ PD9611 enters μ -law mode.

8-Bit Setting Data	LAW Pin	Internal Data
0	0	0
1	0	1
0	1	1
1	1	1

Remark 0: A-law, 1: μ -law

(4) Gain Setting control for transmit/receive

The μ PD9611 can control gain settings independently for the transmit/receive by inputting 8-bit setting data (see **(5) Control of SPDATA pin**) from the SPDATA pin for four channels. Gain can be set from +7.5 to -8.0 dB for the transmit and +0.0 dB t o -15.5 dB for the receive in 0.5 dB steps.

8-bit setting data input from SPDATA pin specifies the channel set in the first 8 bits, and performs selection of transmit/receive and gain setting in the second 8 bits.



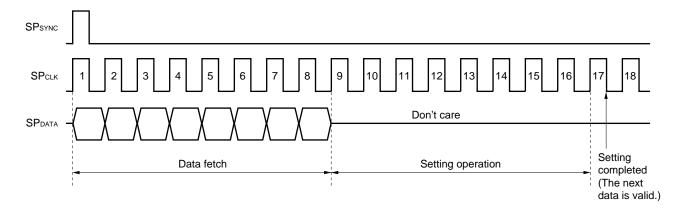
(5) Control of SPDATA pin

If SPsync pin is set to the high level in synchronization with the rising edge (\uparrow) of the data clock applied to the SPclk pin, data of the SPdata pin is latched by the falling edge (\downarrow) of the data clock and consecutively fetched in.

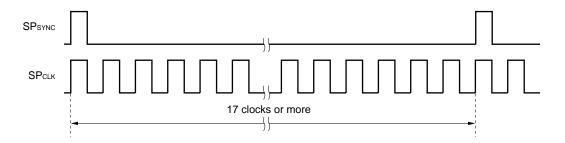
After the 8-bit data has been fetched, the setting operation is performed according to the data.

This setting operation is performed during the 8 clocks after fetching the data and the next data is valid at the 17th clock.

Therefore, when setting 1 word (8 bits) of data, input 17 clocks or more to the SPCLK pin.

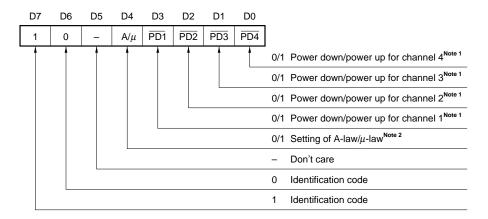


Ensure that 17 clocks or more are input to the SPclk pin between the rising of SPsyNc and the rising of the next SPsyNc.

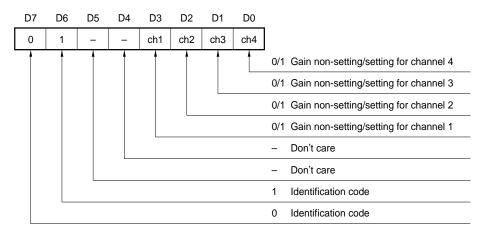




• A/μ-law, power down control



- Notes 1. Default setting is power down mode.
 - 2. Default setting is A-law mode.
- Transmit/receive gain setting control (1st word)



Transmit/receive gain setting control (2nd word)

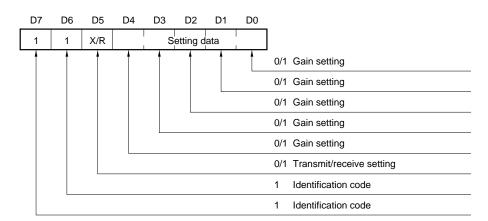




Table of Gain Setting Codes

(1/2)

Setting Item	Setting				1st \	Nord							2nd \	Nord	l		(1/2)
	Level	D7	D6	D5	D4	D3	D2	D1	D0	D7	D6	D5	D4	D3	D2	D1	D0
Gain setting for transmit	+7.5 dB	0	1	_	_	ch1		ch3		1	1	0	1	0	0	0	0
	+7.0 dB									1	1	0	1	0	0	0	1
	+6.5 dB									1	1	0	1	0	0	1	0
	+6.0 dB									1	1	0	1	0	0	1	1
	+5.5 dB									1	1	0	1	0	1	0	0
	+5.0 dB									1	1	0	1	0	1	0	1
	+4.5 dB									1	1	0	1	0	1	1	0
	+4.0 dB									1	1	0	1	0	1	1	1
	+3.5 dB									1	1	0	1	1	0	0	0
	+3.0 dB									1	1	0	1	1	0	0	1
	+2.5 dB									1	1	0	1	1	0	1	0
	+2.0 dB									1	1	0	1	1	0	1	1
	+1.5 dB									1	1	0	1	1	1	0	0
	+1.0 dB									1	1	0	1	1	1	0	1
	+0.5 dB									1	1	0	1	1	1	1	0
	0.0 dB ^{Note}									1	1	0	1	1	1	1	1
	-0.5 dB									1	1	0	0	0	0	0	0
	-1.0 dB									1	1	0	0	0	0	0	1
	-1.5 dB									1	1	0	0	0	0	1	0
	-2.0 dB									1	1	0	0	0	0	1	1
	-2.5 dB									1	1	0	0	0	1	0	0
	-3.0 dB									1	1	0	0	0	1	0	1
	-3.5 dB									1	1	0	0	0	1	1	0
	-4.0 dB									1	1	0	0	0	1	1	1
	-4.5 dB									1	1	0	0	1	0	0	0
	-5.0 dB									1	1	0	0	1	0	0	1
	−5.5 dB									1	1	0	0	1	0	1	0
	-6.0 dB									1	1	0	0	1	0	1	1
	-6.5 dB									1	1	0	0	1	1	0	0
	-7.0 dB									1	1	0	0	1	1	0	1
	-7.5 dB									1	1	0	0	1	1	1	0
	-8.0 dB									1	1	0	0	1	1	1	1

Note Default setting

(2/2)

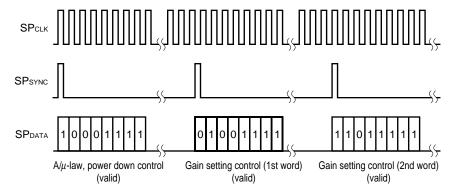
0 111 11	0 "	I								(2/2)							
Setting Item	Setting		D.O.	D.5		Nord		D 4	D 0	D7	D 0	I		Word		D.4	D 0
	Level	D7	D6	D5	D4	D3			D0	D7	D6	D5	D4	D3	D2	D1	D0
Gain setting for receive	0.0 dB ^{Note}	0	1	-	_	ch1	ch2	ch3	ch4	1	1	1	1	1	1	1	1
	-0.5 dB									1	1	1	1	1	1	1	0
	-1.0 dB									1	1	1	1	1	1	0	1
	–1.5 dB									1	1	1	1	1	1	0	0
	-2.0 dB									1	1	1	1	1	0	1	1
	-2.5 dB									1	1	1	1	1	0	1	0
	-3.0 dB									1	1	1	1	1	0	0	1
	-3.5 dB									1	1	1	1	1	0	0	0
	-4.0 dB									1	1	1	1	0	1	1	1
	-4.5 dB									1	1	1	1	0	1	1	0
	−5.0 dB									1	1	1	1	0	1	0	1
	−5.5 dB									1	1	1	1	0	1	0	0
	-6.0 dB									1	1	1	1	0	0	1	1
	-6.5 dB									1	1	1	1	0	0	1	0
	-7.0 dB									1	1	1	1	0	0	0	1
	-7.5 dB									1	1	1	1	0	0	0	0
	-8.0 dB									1	1	1	0	1	1	1	1
	-8.5 dB									1	1	1	0	1	1	1	0
	-9.0 dB									1	1	1	0	1	1	0	1
	-9.5 dB									1	1	1	0	1	1	0	0
	-10.0 dB									1	1	1	0	1	0	1	1
	-10.5 dB									1	1	1	0	1	0	1	0
	-11.0 dB									1	1	1	0	1	0	0	1
	-11.5 dB									1	1	1	0	1	0	0	0
	-12.0 dB									1	1	1	0	0	1	1	1
	-12.5 dB									1	1	1	0	0	1	1	0
	-13.0 dB									1	1	1	0	0	1	0	1
	-13.5 dB									1	1	1	0	0	1	0	0
	-14.0 dB									1	1	1	0	0	0	1	1
	-14.5 dB									1	1	1	0	0	0	1	0
	-15.0 dB									1	1	1	0	0	0	0	1
	-15.5 dB									1	1	1	0	0	0	0	0

Note Default setting

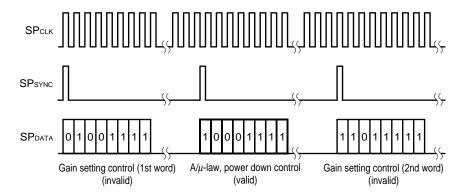


Gain setting control is set by inputting 8-bit data fo the 1st word first and inputting 8-bit data of the 2nd word in synchronization with the next rising edge of SPsync. However, if data other than the identification code of the 2nd word is input after the input of the 1st word, the contents of the 1st word are ignored.

(i) When gain setting control is valid

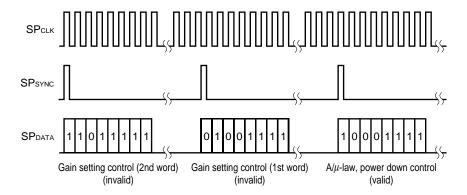


(ii) When gain setting control is invalid -1



Remark Because A/ μ -law, power down control is input after input of gain setting control (1st word), gain setting control (1st word) becomes invalid and gain setting control (2nd word) also becomes invalid.

(iii) When gain setting control is invalid -2



Remark Because gain setting control (2nd word) is input before gain setting control (1st word), gain setting control (1st word) becomes invalid. Then, because A/μ -law, power down control is input even if gain setting control (1st word) is input, gain setting control (1st word) becomes invalid.



4. ELECTRICAL SPECIFICATIONS (PRELIMINARY)

ABSOLUTE MAXIMUM RATINGS (TA = 25 °C)

Item	Symbol	Condition	Rating	Unit
Supply voltage	V _{DD}	AVDD1, AVDD2, AVDD3, AVDD4, DVDD	-0.3 to +7.0	V
Analog input voltage	Vain	Ain1, Ain2, Ain3, Ain4, ACOMin1, ACOMin2, ACOMin3, ACOMin4	-0.3 to V _{DD} +0.3	
Digital input voltage	Vdin	DR, DCLR, FSC, LAW, PD1, PD2, PD3, PD4, SPCLK, SPSYNC, SPDATA, RST	-0.3 to V _{DD} +0.3	
Voltage applied to analog output pin	VAOUT	Aout1, Aout2, Aout3, Aout4, ACOMout1, ACOMout2, ACOMout3, ACOMout4	-0.3 to V _{DD} +0.3	
Voltage applied to digital output pin	VDOUT	Dx	-0.3 to V _{DD} +0.3	
Power dissipation	Рт		500	mW
Ambient operating temperature	TA		-20 to +85	°C
Storage temperature	Tstg		-65 to +150	1

Caution Product quality may suffer if the absolute maximum rating is exceeded for even a single parameter or even momentarily. That is, the absolute maximum ratings are rated values at which the product is on the verge of suffering physical damage, and therefore the product must be used under conditions which ensure that the absolute maximum ratings are not exceeded.

RECOMMENDED OPERATION CONDITIONS (TA = -20 to +85 °C, VDD = 5 V \pm 5 %, GND = 0 V, fDCLK = 2048 kHz)

(1) DC condition

Item	Symbol	Condition	MIN.	TYP.	MAX.	Unit
Ambient operating temperature	TA		-20	+25	+85	°C
Supply voltage	V _{DD}	AVDD1, AVDD2, AVDD3, AVDD4, DVDD	4.75	5.0	5.25	V
Analog input voltage	Vai	Ain1, Ain2, Ain3, Ain4 (ACOM as reference)	-1.0		+1.0	
Analog output load resistance	RLOAD	Аоит1, Аоит2, Аоит3, Аоит4	50			kΩ
Analog output load capacitance	CLOAD				50	pF
High level input voltage	V _{IH1}	DR, DCLK, FSC, LAW, PD1, PD2, PD3, PD4, SPCLK, SPSYNC, SPDATA	2.0		V _{DD}	V
	V _{IH2}	RST	0.8×VDD		V _{DD}	
Low level input voltage	V _{IL1}	DR, DCLK, FSC, LAW, PD1, PD2, PD3, PD4, SPCLK, SPSYNC, SPDATA	0		0.8	
	V _{IL2}	RST	0		0.2×V _{DD}	



(2) AC condition

Item	Symbol	Condition	MIN.	TYP.	MAX.	Unit
Data clock frequency	fcLK	(= 1/tcx) ±50 ppm		2048		kHz
Data clock pulse width	tclk		200			ns
Frame synchronous clock frequency	fs	±50 ppm		8.0		kHz
High level frame synchronous pulse width	twns		200			ns
Low level frame synchronous pulse width	twLs		8			μs
Clock rise time	tR				50	ns
Clock fall time	tF				50	ns
Float in synchronous timing	tcsD1				100	ns
	tcsD2		40			ns
Frame synchronous clock and data clock high level width	twnsc		100			ns
D _R setup time	tosr	Note	65			ns
D _R hold time	tohr	Note	120			ns
SPDATA clock frequency	fspclk				2048	kHz
SPDATA setup time	tgsr	Note	100			ns
SPDATA hold time	t GHR	Note	100			ns
Float in SP synchronous timing	trsp		40			ns

Note Set the rise time and fall time of the digital input waveform and clock signal used for measuring timings to 5 ns.



DC CHARACTERISTICS

(TA = -20 to +85 $^{\circ}$ C, VDD = 5 \pm 0.25 V, GND = 0 V, fDCLK = 2048 kHz, and all output pins are unloaded.)

(1) Power consumption

Item	Symbol	Condition	MIN.	TYP.	MAX.	Unit
Circuit current	IDD	All channels in normal operation		23	30	mA
Power-down circuit current	IDDPD	All channels in power-down mode		5	6	

(2) Digital interface

Item	Symbol	Condition	MIN.	TYP.	MAX.	Unit
Digital input current	Iп	DR, DCLK, FSC, LAW, PD1, PD2, PD3,	-10		+10	μΑ
		PD4, SPclk, SPsync, SPdata, RST				
		Each pin 0 ≤ V _{DIN} ≤ V _{DD}				
3-state leakage current	Iι	Dx pin 0 ≤ V _{DIN} ≤ V _{DD}	-10		+10	
High level output voltage	Vон	Dx pin Iон = -150μ A	V _{DD} -0.3			V
Low level output voltage	Vol	Dx pin loL = 0.8 mA			0.4	
Digital output pin output capacitance	Сод	f = 1 MHz, 0 V other than unmeasured pins			15	pF
Digital input pin input capacitance	Cid	f = 1 MHz, 0 V other than unmeasured pins			10	

(3) Transmit amplifier (AIN1, AIN2, AIN3, AIN4 pins)

Item	Symbol	Condition	MIN.	TYP.	MAX.	Unit
Input bias current	Ів		-10		+10	μΑ
Input resistance	Rin		1			МΩ
Input capacitance	Cin				10	pF

(4) Receive power amplifier (Aout1, Aout2, Aout3, Aout4 pins)

Item	Symbol	Condition	MIN.	TYP.	MAX.	Unit
Output offset voltage	Voa	D _R = +0 code ACOM as reference	-50		+50	mV
Maximum output voltage	Vом	ACOM as reference	-1.02		+1.02	V
Output resistance	Rоит			1		Ω

(5) Signal reference voltage output (ΑCOΜουτ1, ΑCOΜουτ2, ΑCOΜουτ3, ΑCOΜουτ4 pins)

Item	Symbol	Condition	MIN.	TYP.	MAX.	Unit
Output voltage	Vасом		2.35	2.4	2.45	٧



AC CHARACTERISTICS (Ta = -20 to +85 $^{\circ}\text{C},~\text{Vdd}$ = 5 \pm 0.25 V, GND = 0 V, fdclk = 2048 kHz)

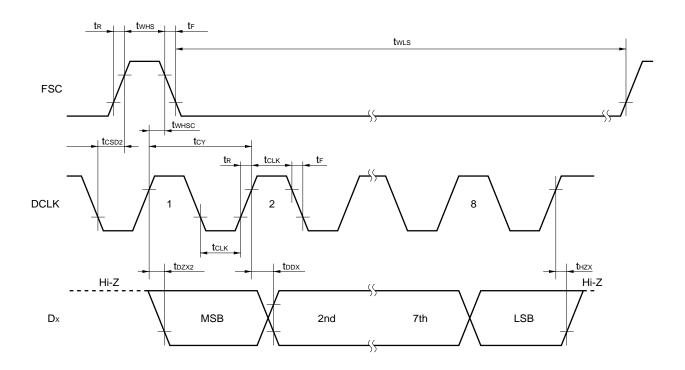
Item	Symbol	Condition M		TYP.	MAX.	Unit
Data enable delay time	t _{DZX1}	Dx when FSC is behind DCLK			100	ns
	t _{DZX2}	Dx when FSC is ahead of DCLK			100	ns
Data delay time	todx	Dx pin			100	ns
Data hold time	tHZX	Dx pin		25		ns



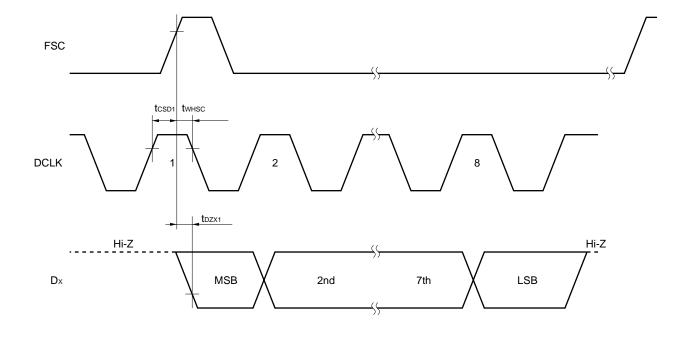
(1) Transmit timing

TIMING CHARTS

(a) When FSC is ahead of DCLK



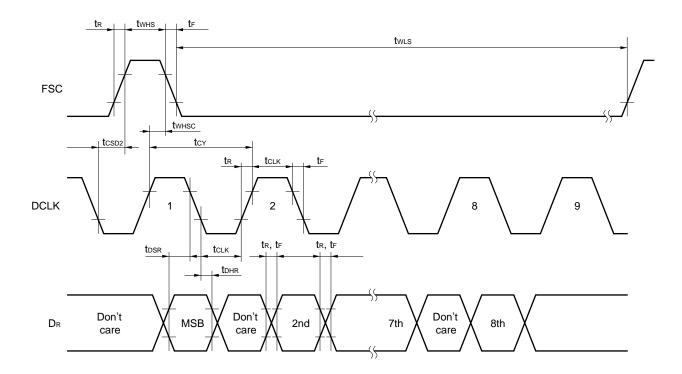
(b) When FSC is behind DCLK



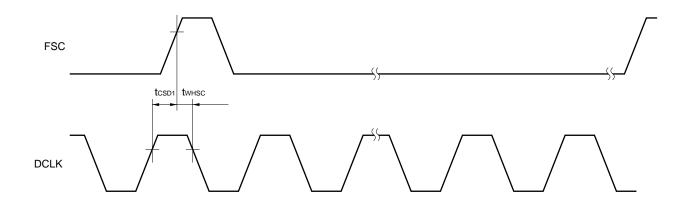


(2) Receive timing

(a) When FSC is ahead of DCLK

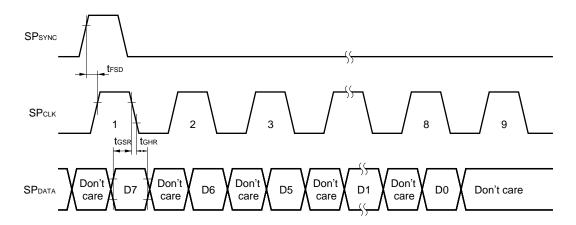


(b) When FSC is behind DCLK

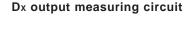


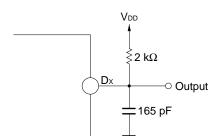


(3) Gain setting timing

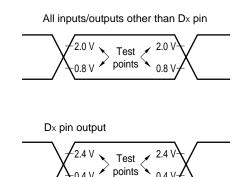


Remark The relationship between SPsync and SPclk is the same as in the receive timing.

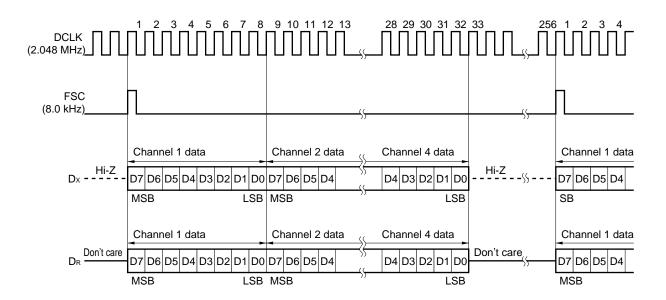




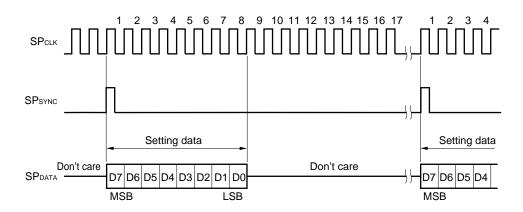




(4) Transmit, receive PCM data input/output timing charts



(5) Setting data input timing





TRANSMISSION CHARACTERISTICS (Ta = -20 to +85 $^{\circ}$ C, Vdd = 5 \pm 0.25 V, GND = 0 V, fdclk = 2048 kHz)

Item	Symbol	Condition	Setting Value	Unit
Zero transmission level point (transmit)	OTLPx	Referenced to 600 Ω	-3.8	dBm
Zero transmission level point (receive)	OTLPx	Referenced to 600 Ω	-3.8	dBm

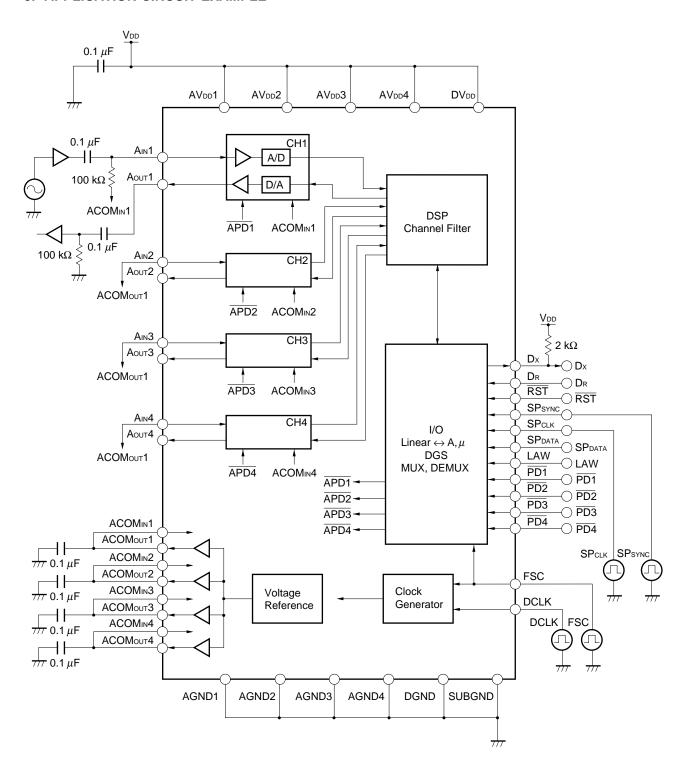
Item	Symbol	Condition		MIN.	TYP.	MAX.	Unit
Insertion loss	IL	A/D input signal 0 dBm0 1 kHz		-0.3		+0.3	dB
		D/A input signal 0 dBm0 1 kHz		-0.3		+0.3	
Transmission loss frequency	FRX	A/D	60 Hz	24.0		_	dB
characteristics		Reference input signal	200 Hz	0		2.0	
		1015 Hz 0 dBm0	300 to 3000 Hz	-0.15		+0.15	
			3200 Hz	-0.15		+0.65	
			3400 Hz	0		0.8	
			3780 Hz	+6.5			
	FRR	D/A	0 to 3000 Hz	-0.15		+0.15	
		Reference input signal	3200 Hz	-0.15		+0.65	
		1015 Hz 0 dBm0	3400 Hz	0		+0.8	1
			3780 Hz	+6.5			
Gain tracking (tone method)	GTx	A/D	+3 to -40 dBm0	-0.2		+0.2	dB
		Reference input signal	-50 dBm0	-0.5		+0.5	
		-10 dBm0 f = 700 to 1100 Hz	-55 dBm0	-1.0		+1.0	
	GTR	D/A	+3 to -40 dBm0	-0.2		+0.2	
		Reference input signal	-50 dBm0	-0.5		+0.5	
		-10 dBm0 f = 700 to 1100 Hz	-55 dBm0	-1.0		+1.0	
Transmit/receive channel	SDx	A/D	+3 to -30 dBm0	36			dB
overall power distortion ratio		Input signal	-40 dBm0	30			
(tone method)		f = 700 to 1100 Hz	-45 dBm0	25			
	SDR	D/A	+3 to -30 dBm0	36			
		Input signal	-40 dBm0	30			
		f = 700 to 1100 Hz	-45 dBm0	25			
Absolute delay characteristic	DA	A/A Input signal = 0 dBm0	1			540	μs
Absolute delay distortion	Do	A/A	500 Hz			1400	μs
frequency characteristics			600 Hz			700	1
			1000 to 2600 Hz			200	
			2800 Hz			1400	1
Idle channel noise	ICNADA	A/D A-law Psophometric weig	ghted			-72	dBm0p
	ICNDAA	D/A A-law Psophometric weig				-80	
	ICN _{ADμ}	A/D μ -law C-message weight	ed			18	dBrnc0
	ICNDAμ	D/A μ -law C-message weight	ed			10	



Item	Symbol	Condition	MIN.	TYP.	MAX.	Unit
Cross talk between channels	СТ	A/A Input signal = 0 dBm0			-70	dB
Power supply rejection ratio	PSRR	AVDD1, AVDD2, AVDD3, AVDD4, DVDD = $5 \text{ V} \pm 100 \text{ mVp-p}$			-25	dB
Coder offset		A/D Input signal 0 V	-5		+5	-
Mutual modulation (2 tones)	IMD	A/D Input signal: f1, f2; 300 to 3400 Hz, -4 to -21 dBm0 Measuring signal: 2 × f1 - f2 level (2 × f1 - f2) vs level (f1, f2)	44.0			dB
		D/A Input signal: f1, f2; 300 to 3400Hz, -4 to -21 dBm0 Measuring signal: 2 × f1 - f2 level (2 × f1 - f2) vs level (f1, f2)	44.0			dB
Discrimination		A/D Input signal: f; 4396 to 7796 Hz 0 dBm0 Measuring signal: 8000 - fHz			-27	dB
Out-of-band spurious		D/A Input signal: f; 204 to 3604 Hz 0 dBm0 Measuring signal: 8000 – fHz			-27	dB
In-band spurious		A/D Input signal: f; 700 to 1100 Hz 0 dBm0 Measuring signal: Any frequency			-45	dB
		D/A Input signal: f; 700 to 1100 Hz 0 dBm0 Measuring signal: Any frequency			-45	dB
Single frequency noise	Nsf	D/A Gain setting = 0 dB Measuring signal: f = up to 256 kHz			-54	dBm0
Transmit gain setting	ΔDGSx	A/D difference from reference setting value	-0.15		+0.15	dB
Receive gain setting	ΔDGSR	D/A difference from reference setting value	-0.15		+0.15	

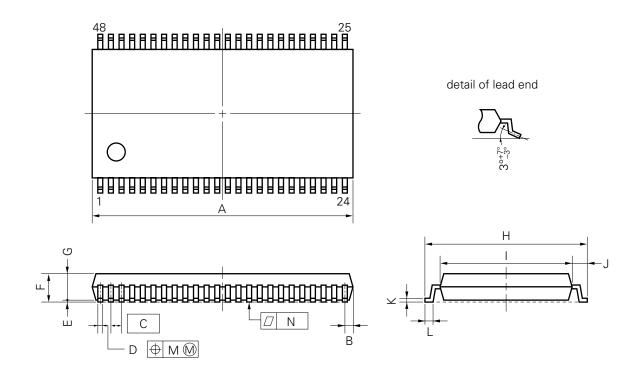


5. APPLICATION CIRCUIT EXAMPLE



6. PACKAGE DRAWINGS

48 PIN PLASTIC SHRINK SOP (375 mil)



NOTE

Each lead centerline is located within 0.10 mm (0.004 inch) of its true position (T.P.) at maximum material condition.

P48GT-65-375B-1

ITEM	MILLIMETERS	INCHES
А	16.21 MAX.	0.639 MAX.
В	0.63 MAX.	0.025 MAX.
С	0.65 (T.P.)	0.026 (T.P.)
D	0.30±0.10	$0.012^{+0.004}_{-0.005}$
Е	0.125±0.075	0.005±0.003
F	2.0 MAX.	0.079 MAX.
G	1.7±0.1	0.067±0.004
Н	10.0±0.3	0.394+0.012
I	8.0±0.2	0.315±0.008
J	1.0±0.2	$0.039^{+0.009}_{-0.008}$
K	$0.15^{+0.10}_{-0.05}$	$0.006^{+0.004}_{-0.002}$
L	0.5±0.2	0.020+0.008
М	0.10	0.004
N	0.10	0.004



7. RECOMMENDED SOLDERING CONDITIONS

This product should be soldered and mounted under the conditions recommended below.

For details of recommended soldering conditions, refer to the information document **Semiconductor Device Mounting Technology Manual (C10535E)**.

For soldering methods and conditions other than those recommended, please contact your NEC sales representative.

SURFACE MOUNT TYPE

 μ PD9611GT: 48-pin shrink SOP (375 mil)

Soldering Method	Soldering Conditions	Recommended Condition Symbol
Infrared reflow	Package peak temperature: 235 °C Duration: 30 sec. max. (210 °C or above) Number of times: 2 max. Time limit: 3 days ^{Note} (thereafter, 10-hour prebaking at 125 °C required.) <cautions> (1) Wait for the device temperature to return to normal after the first reflow before starting the second reflow. (2) Do not perform flux cleaning with water after the first reflow.</cautions>	IR-35-103-2
Pin heating	Pin temperature: 300 °C max. Duration: 3 sec. max. (per side of device)	_

Note For the storage period after unpacking from the dry-pack, storage conditions are max. 25 °C, 65 % RH.

NOTES FOR CMOS DEVICES -

(1) PRECAUTION AGAINST ESD FOR SEMICONDUCTORS

Note: Strong electric field, when exposed to a MOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it once, when it has occurred. Environmental control must be adequate. When it is dry, humidifier should be used. It is recommended to avoid using insulators that easily build static electricity. Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work bench and floor should be grounded. The operator should be grounded using wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions need to be taken for PW boards with semiconductor devices on it.

(2) HANDLING OF UNUSED INPUT PINS FOR CMOS

Note: No connection for CMOS device inputs can be cause of malfunction. If no connection is provided to the input pins, it is possible that an internal input level may be generated due to noise, etc., hence causing malfunction. CMOS device behave differently than Bipolar or NMOS devices. Input levels of CMOS devices must be fixed high or low by using a pull-up or pull-down circuitry. Each unused pin should be connected to VDD or GND with a resistor, if it is considered to have a possibility of being an output pin. All handling related to the unused pins must be judged device by device and related specifications governing the devices.

③ STATUS BEFORE INITIALIZATION OF MOS DEVICES

Note: Power-on does not necessarily define initial status of MOS device. Production process of MOS does not define the initial operation status of the device. Immediately after the power source is turned ON, the devices with reset function have not yet been initialized. Hence, power-on does not guarantee out-pin levels, I/O settings or contents of registers. Device is not initialized until the reset signal is received. Reset operation must be executed immediately after power-on for devices having reset function.

[MEMO]

The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.

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NEC devices are classified into the following three quality grades:

"Standard", "Special", and "Specific". The Specific quality grade applies only to devices developed based on a customer designated "quality assurance program" for a specific application. The recommended applications of a device depend on its quality grade, as indicated below. Customers must check the quality grade of each device before using it in a particular application.

Standard: Computers, office equipment, communications equipment, test and measurement equipment, audio and visual equipment, home electronic appliances, machine tools, personal electronic equipment and industrial robots

Special: Transportation equipment (automobiles, trains, ships, etc.), traffic control systems, anti-disaster systems, anti-crime systems, safety equipment and medical equipment (not specifically designed for life support)

Specific: Aircrafts, aerospace equipment, submersible repeaters, nuclear reactor control systems, life support systems or medical equipment for life support, etc.

The quality grade of NEC devices is "Standard" unless otherwise specified in NEC's Data Sheets or Data Books. If customers intend to use NEC devices for applications other than those specified for Standard quality grade, they should contact an NEC sales representative in advance.

Anti-radioactive design is not implemented in this product.

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